Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
    - Class Q Military
    - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)

    - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS259
8-Bit Addressable Latches

General Description

These 8-bit addressable latches are designed for general purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

Four distinct modes of operation are selectable by controlling the clear and enable inputs as enumerated in the function table. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch will follow the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possibility of entering erroneous data in the latches, the enable should be held HIGH (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output will follow the level of the D input with all other outputs LOW. In the clear mode, all outputs are LOW and unaffected by the address and data inputs.

Features

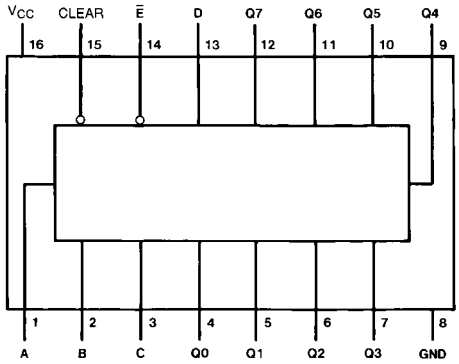
- 8-Bit parallel-out storage register performs serial-to-parallel conversion with storage
- Asynchronous parallel clear
- Active high decoder
- Enable/disable input simplifies expansion
- Direct replacement for Fairchild DM9334
- Expandable for N-bit applications
- Four distinct functional modes
- Typical propagation delay times:
  - Enable-to-output 18 ns
  - Data-to-output 16 ns
  - Address-to-output 21 ns
  - Clear-to-output 17 ns
- Fan-out
  - I_{OL} (sink current) 8 mA
  - I_{OH} (source current) −0.4 mA
- Typical I_{CC} 22 mA

Ordering Code:

Order Number	Package Number	Package Description
DM74LS259M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS259WM	M16B	16-Lead Small Outline Intergrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
DM74LS259N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

Inputs		Output of Addressed Latch	Each Other Output	Function
Clear	$\overline{E}$			
H	L	D	Q_{i0}	Addressable Latch
H	H	Q_{i0}	Q_{i0}	Memory
L	L	D	L	8-Line Demultiplexer
L	H	L	L	Clear

Latch Selection Table

Select Inputs			Latch Addressed
C	B	A	
L	L	L	0
L	L	H	1
L	H	L	2
L	H	H	3
H	L	L	4
H	L	H	5
H	H	L	6
H	H	H	7

H = HIGH Level
L = LOW Level
D = the Level of the Data Input
Q_{i0} = the Level of Q_i (i = 0, 1,...7, as Appropriate) before the Indicated Steady-State Input Conditions Were Established.

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter		Min	Nom	Max	Units
V_{CC}	Supply Voltage		4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage		2			V
V_{IL}	LOW Level Input Voltage				0.8	V
I_{OH}	HIGH Level Output Current				−0.4	mA
I_{OL}	LOW Level Output Current				8	mA
t_W	Pulse Width	Enable	15			ns
	(Note 5)	Clear	15			
t_{SU}	Setup Time	Data	15↑			ns
	(Note 2)(Note 3)(Note 4)(Note 5)	Select	15↓			
t_H	Hold Time	Data	2.5↑			ns
	(Note 2)(Note 3)(Note 5)	Select	2.5↑			
T_A	Free Air Operating Temperature		0		70	°C

Note 2: The symbols (↓, ↑) indicate the edge of the clock pulse used for reference: ↑ for rising edge, ↓ for falling edge.

Note 3: Setup and hold times are with reference to the enable input.

Note 4: The select-to-enable setup time is the time before the HIGH-to-LOW enable transition that the select must be stable so that the correct latch is selected and the others not affected.

Note 5: $T_A = 25°C$ and $V_{CC} = 5V$.

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 6)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V V_I = 10V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.4	mA
	Enable	V_{CC} = Max, V_I = 0.4V			−0.8	
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 7)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 8)		22	36	mA

Note 6: All typicals are at $V_{CC} = 5V$, $T_A = 25°C$.

Note 7: Not more than one output should be shorted at a time, and the duration should not exceed one second.

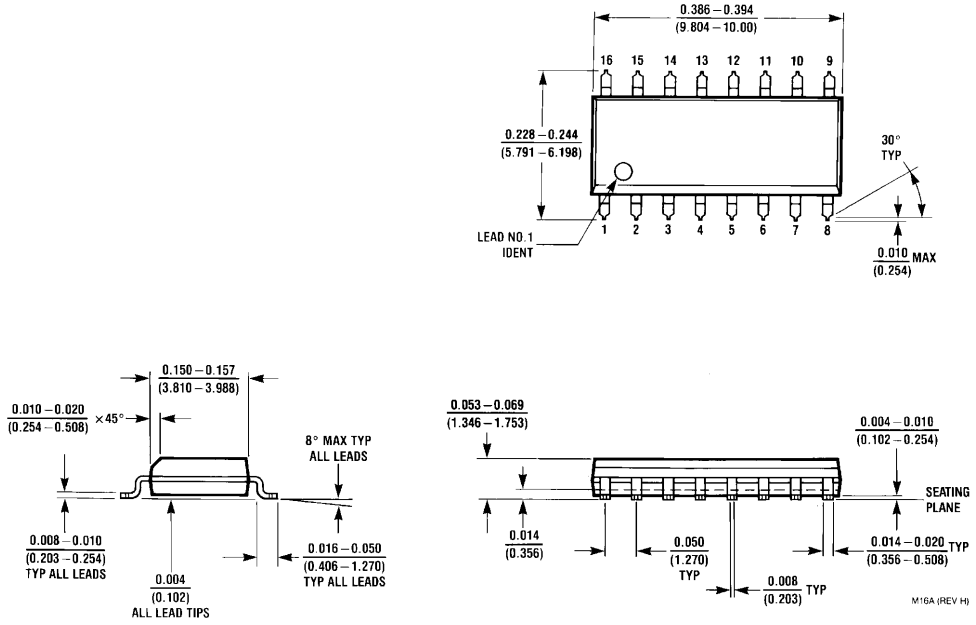
Note 8: I_{CC} is measured with all inputs at 4.5V, and all outputs OPEN.

Switching Characteristics

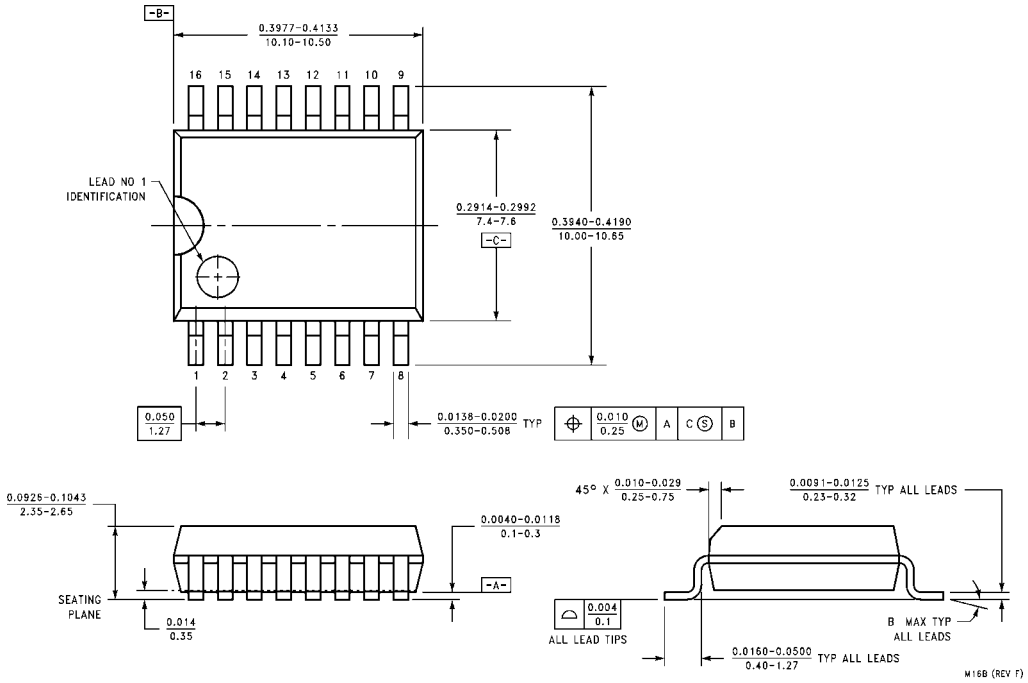
at V_{CC} = 5V and T_A = 25°C

Symbol	Parameter	From (Input) To (Output)	C_L = 50 pF, R_L = 2 kΩ		Units
			Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to Output		38	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to Output		32	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Data to Output		35	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Data to Output		30	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select to Output		41	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select to Output		38	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Clear to Output		36	ns

Physical Dimensions inches (millimeters) unless otherwise noted

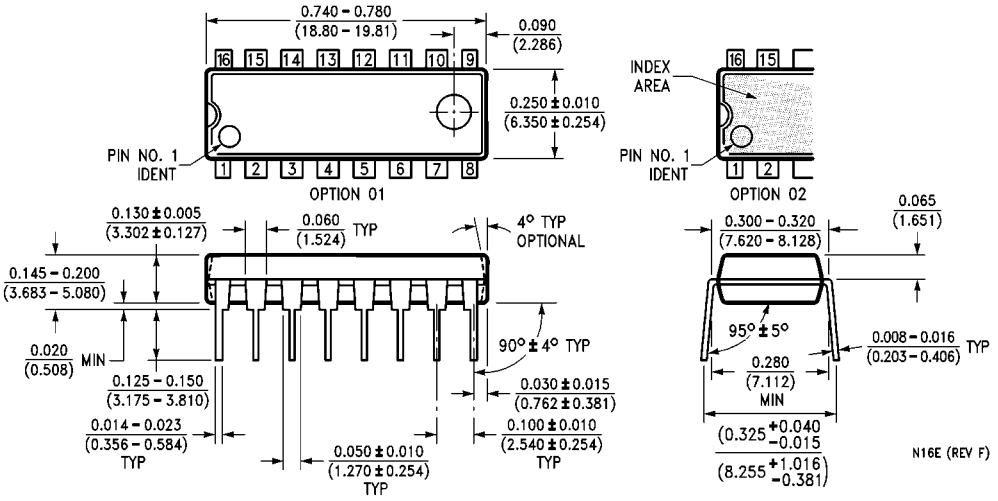


16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A



16-Lead Small Outline Intergrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M16B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E